ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities and the declaration entities are an entities and the declaration entities are an entites are an	on of the su compasses	bstances v all lower	vithin the manufactule level materials for v	urer listed which the	item. Note: manufactur	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infor					Ifg Informa	ation			
upplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respor	Response Date*			
onsemi										2024-0	2024-05-09			
Contact Name Title - Conta			ntact			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product Env			viro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			resentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product En			Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	ester Item Number Mfr Item N		Number Mfr Item Name			Effective Date Version Manufacturing Sit		anufacturing Site		Weight*	UOM	Unit Type		
	BSS123	3SS123L FET 100		T 100V 6.0 mOhm SOT23		2024-05-09		C	CNM		8.02	mg	Each	
Ianufacturing Proccess Informa	tion							ŕ						
Terminal Plating / Grid Array M	Material Terminal Base		Alloy J-STD-020 MSL Rati		Rating	Peak Proce	Peak Process Body Temperature		Max Time at Pea	k Tempera	ture Num	nber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	1			260 C		С	30 seco		seconds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.05	mg	Supplier	Silicon (Si)	7440-21-3		0.05	mg
Lead Frame 2.9	2.92	mg	Supplier	Silver (Ag)	7440-22-4		0.0651	mg
			Supplier	Chromium (Cr)	7440-47-3		0.007	mg
			Supplier	Manganese (Mn)	7439-96-5		0.0356	mg
			В	Nickel (Ni)	7440-02-0		1.199	mg
			Supplier	Iron (Fe)	7439-89-6		1.6133	mg
Mold Compound-Black	4.9	mg		Metal Hydroxide	proprietary data		0.1715	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.392	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.92	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.392	mg
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg